L	Hits	Search Text	DB	Trimo etc
Number			מע	Time stamp
1-	9	MILLER-MARK-LEE	USPAT;	2003/12/23
			US-PGPUB;	08:44
	1		EPO; JPO;	
			DERWENT; IBM TDB	
-	7	MILLER-MARK-L	USPAT;	2003/12/22
			US-PGPUB;	16:06
			EPO; JPO;	
			DERWENT;	
12	177	(156/\$ and rotor) and (tack or tacky or	IBM_TDB	0000 /10 /00
1	1 1,7	tacking or tackified)	USPAT; US-PGPUB;	2003/12/23 10:03
		January of Sacriffed,	EPO; JPO;	10.03
			DERWENT;	
	l .		IBM_TDB	
-	84	conductor same insulator same (adhesive	USPAT;	2003/12/23
		or resin or glue) same (cure or curing or cured or bond or bonded or bonding) same	US-PGPUB;	10:18
		coil	EPO; JPO; DERWENT;	
	-	·	IBM TDB	
-	18	conductor same insulator same (adhesive	USPAT;	2003/12/24
		or resin or glue) same ((semi or partial	US-PGPUB;	10:18
		or partially) near (cure or curing or	EPO; JPO;	
		cured or bond or bonded or bonding))	DERWENT; IBM TDB	
_	7	("0758986" "3617617" "3676579"	USPAT	2003/12/23
ļ		"3801392" "4197348" "4601931"	OSPAI	10:28
		"4900879").PN.		
-	0	6656317.URPN.	USPAT	2003/12/23
	1 14	4107040 17001		10:31
-	14	4197348.URPN.	USPAT	2003/12/23
_	7	("3480471" "3582509" "3634326"	USPAT	10:31 2003/12/23
		"3657196" "3686045" "3721523"	OJIAI	11:15
	ĺ	"3764584").PN.		
-	9	3960803.URPN.	USPAT	2003/12/23
l _	5	 ("2757298" "3629024" "3079519"		11:15
-]	(2757296	USPAT	2003/12/23
-	10	2757298.URPN.	USPAT	2003/12/23
				12:52
-	132	((((semi or partial or partially) near	USOCR	2003/12/23
		(cure or curing or cured or bond or		12:54
1	1	bonded or bonding))) and conductor) and coil		
-	2	3202558.URPN.	USPAT	2003/12/23
I				13:01
-	4	3674627.URPN.	USPAT	2003/12/23
1		/ /b 6/2>		13:33
1 -	40	<pre>(mica near (tape or film)) and (adhesive or resin) and ((semi or partial or</pre>	USPAT; US-PGPUB;	2003/12/23
1		partially) near (cure or curing or cured	EPO; JPO;	13.07
		or bond or bonded or bonding))	DERWENT;]
			IBM_TDB	
-	5	("3180778" "3584758" "4529672"	USPĀT	2003/12/23
l _	2	"4938833" "5536278").PN. 5916515.URPN.	IIGD) m	15:03
_	4	J910313.UKPN.	USPAT	2003/12/23 15:03
-	2	("5261156").PN.	USPAT;	2003/12/23
		•	US-PGPUB;	15:07
		•	EPO; JPO;	
			DERWENT;	
_	26	5261156.URPN.	IBM_TDB USPAT	2003/12/23
	[20]	0201100. ORFN.	USPAT	15:07
		and the same of th		

	· · · · · · · · · · · · · · · · · · ·			
-	18	,	USPAT	2003/12/23
1	ļ	"4242157" "4269759" "4442966"		15:08
		"4483889" "4578215" "4661192"		
		"4811081" "4818823" "5261156"		
		"5296063" "5372750" "5463190"		i
	1	"5611884" "5842273" "5879965").PN.	İ	
-	62	(conductor and (glass near tape)) and	USOCR	2003/12/24
1		ероху		08:45
-	211	conductor and copper and (glass near	USOCR	2003/12/24
		(tape or cloth)) and (cure or curing or		10:09
		cured)		10.03
-	5	("2757298" "3629024" "3079519"	USPAT	2003/12/24
	1	"3458389" "3662199").PN.	1	09:36
-	5	("2674648" "2757298" "2763798"	USPAT	2003/12/24
		"2975088" "3531751").PN.		09:36
-	9	3662199.URPN.	USPAT	2003/12/24
				09:38
ł –	127	(glass near (tape or cloth)) same	USPAT;	2003/12/24
	ļ	conductor same epoxy same copper	US-PGPUB;	09:44
		1 1	EPO; JPO;	03.44
1			DERWENT;	1
			IBM TDB]
-	3	2980566.URPN.	USPAT	2003/12/24
1			002111	10:14
		L	1	1 10:14